



74HC03; 74HCT03

Quad 2-input NAND gate; open-drain output

Rev. 7 — 16 February 2024

Product data sheet

1. General description

The 74HC03; 74HCT03 is a quad 2-input NAND gate with open-drain outputs. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Input levels:
 - For 74HC03: CMOS level
 - For 74HCT03: TTL level
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|---|-------------------|---------|---|--------------------------|
| | Temperature range | Name | Description | Version |
| 74HC03D 74HCT03D | -40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74HC03PW 74HCT03PW | -40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |

4. Functional diagram

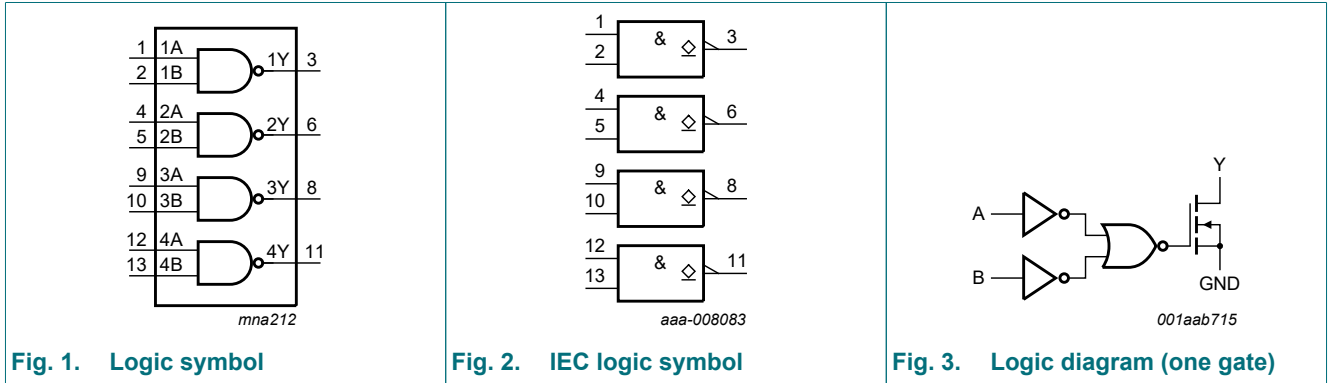


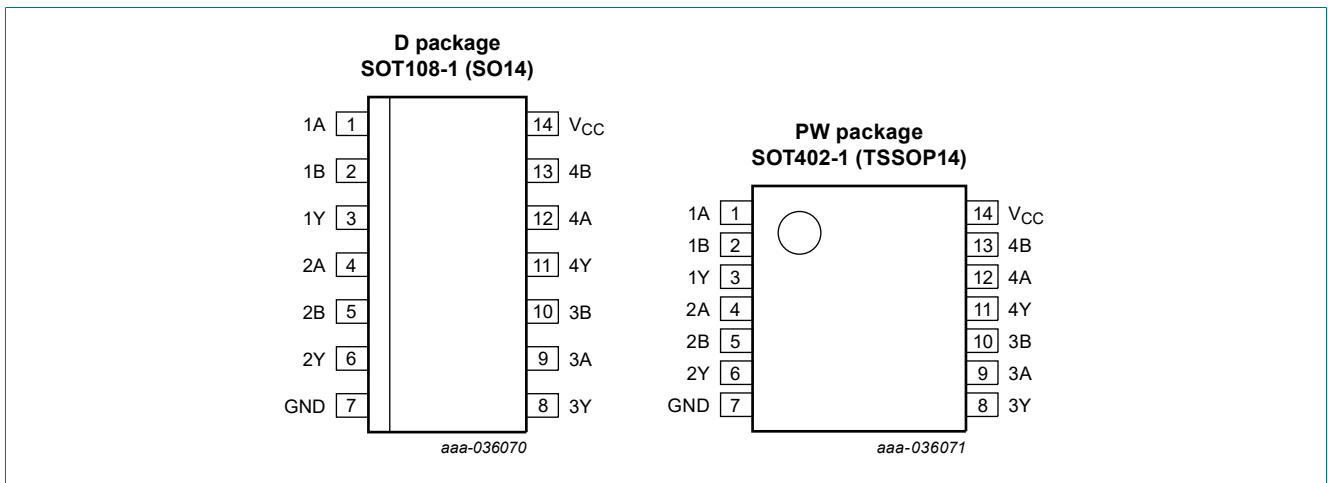
Fig. 1. Logic symbol

Fig. 2. IEC logic symbol

Fig. 3. Logic diagram (one gate)

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|--------------|----------------|
| 1A, 2A, 3A, 4A | 1, 4, 9, 12 | data input |
| 1B, 2B, 3B, 4B | 2, 5, 10, 13 | data input |
| 1Y, 2Y, 3Y, 4Y | 3, 6, 8, 11 | data output |
| GND | 7 | ground (0 V) |
| V _{CC} | 14 | supply voltage |

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

| Input | | Output |
|-------|----|--------|
| nA | nB | nY |
| L | L | Z |
| L | H | Z |
| H | L | Z |
| H | H | L |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--|------|----------|------|
| V_{CC} | supply voltage | | -0.5 | +7 | V |
| V_O | output voltage | [1] | -0.5 | +7 | V |
| I_{IK} | input clamping current | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ | [1] | ± 20 | mA |
| I_{OK} | output clamping current | $V_O < -0.5\text{ V}$ | [1] | -20 | mA |
| I_O | output current | $-0.5\text{ V} < V_O$ | - | -25 | mA |
| I_{CC} | supply current | | - | 50 | mA |
| I_{GND} | ground current | | -50 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | [2] | - | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.
For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | Conditions | 74HC03 | | | 74HCT03 | | | Unit |
|---------------------|-------------------------------------|-------------------------|--------|------|----------|---------|------|----------|------|
| | | | Min | Typ | Max | Min | Typ | Max | |
| V_{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | 4.5 | 5.0 | 5.5 | V |
| V_I | input voltage | | 0 | - | V_{CC} | 0 | - | V_{CC} | V |
| V_O | output voltage | | 0 | - | V_{CC} | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.0\text{ V}$ | - | - | 625 | - | - | - | ns/V |
| | | $V_{CC} = 4.5\text{ V}$ | - | 1.67 | 139 | - | 1.67 | 139 | ns/V |
| | | $V_{CC} = 6.0\text{ V}$ | - | - | 83 | - | - | - | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|------------------|--|--|-------|------|------|------------------|------|-------------------|------|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| 74HC03 | | | | | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | 1.2 | - | 1.5 | - | 1.5 | - | V |
| | | V _{CC} = 4.5 V | 3.15 | 2.4 | - | 3.15 | - | 3.15 | - | V |
| | | V _{CC} = 6.0 V | 4.2 | 3.2 | - | 4.2 | - | 4.2 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | 0.8 | 0.5 | - | 0.5 | - | 0.5 | V |
| | | V _{CC} = 4.5 V | - | 2.1 | 1.35 | - | 1.35 | - | 1.35 | V |
| | | V _{CC} = 6.0 V | - | 2.8 | 1.8 | - | 1.8 | - | 1.8 | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | | | |
| | | I _O = 20 μA; V _{CC} = 2.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 6.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 4.0 mA; V _{CC} = 4.5 V | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| | I _O = 5.2 mA; V _{CC} = 6.0 V | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V | |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 6.0 V | - | 0.1 | - | - | ±1 | - | ±1 | μA |
| I _{oz} | OFF-state output current | V _I = V _{IL} ; V _{CC} = 6.0 V; V _O = V _{CC} or GND | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V | - | 2.0 | - | - | 20 | - | 40 | μA |
| C _I | input capacitance | | - | 3.5 | - | - | - | - | - | pF |
| 74HCT03 | | | | | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | 1.6 | - | 2.0 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | 1.2 | 0.8 | - | 0.8 | - | 0.8 | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V | | | | | | | | |
| | | I _O = 20 μA | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 4.0 mA | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 5.5 V | - | - | ±0.1 | - | ±1 | - | ±1 | μA |
| I _{oz} | OFF-state output current | V _I = V _{IL} ; V _{CC} = 5.5 V; V _O = V _{CC} or GND | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 2.0 | - | 20 | - | 40 | μA |
| ΔI _{CC} | additional supply current | per input pin; V _I = V _{CC} - 2.1 V; I _O = 0 A; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V | - | 100 | 360 | - | 450 | - | 490 | μA |
| C _I | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

10. Dynamic characteristics

Table 7. Dynamic characteristics

$GND = 0\text{ V}$; $C_L = 50\text{ pF}$; for test circuit, see Fig. 5.

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | -40 °C to +125 °C | Unit |
|----------------|-------------------------------|---|-------|-----|-----|---------------------|----------------------|------|
| | | | Min | Typ | Max | Max | Max | |
| 74HC03 | | | | | | | | |
| t_{pd} | propagation delay | nA, nB to nY; see Fig. 4 [1] | | | | | | |
| | | $V_{CC} = 2.0\text{ V}$ | - | 28 | 95 | 120 | 145 | ns |
| | | $V_{CC} = 4.5\text{ V}$ | - | 10 | 19 | 24 | 29 | ns |
| | | $V_{CC} = 5.0\text{ V}$; $C_L = 15\text{ pF}$ | - | 8 | - | - | - | ns |
| | | $V_{CC} = 6.0\text{ V}$ | - | 8 | 16 | 20 | 25 | ns |
| t_t | transition time | see Fig. 4 [2] | | | | | | |
| | | $V_{CC} = 2.0\text{ V}$ | - | 19 | 75 | 95 | 110 | ns |
| | | $V_{CC} = 4.5\text{ V}$ | - | 7 | 15 | 19 | 22 | ns |
| | | $V_{CC} = 6.0\text{ V}$ | - | 6 | 13 | 16 | 19 | ns |
| C_{PD} | power dissipation capacitance | per package; $V_1 = GND$ to V_{CC} [3] | - | 4 | - | - | - | pF |
| 74HCT03 | | | | | | | | |
| t_{pd} | propagation delay | nA, nB to nY; see Fig. 4 [1] | | | | | | |
| | | $V_{CC} = 4.5\text{ V}$ | - | 12 | 24 | 30 | 36 | ns |
| | | $V_{CC} = 5.0\text{ V}$; $C_L = 15\text{ pF}$ | - | 10 | - | - | - | ns |
| t_t | transition time | $V_{CC} = 4.5\text{ V}$; see Fig. 4 [2] | - | 7 | 15 | 19 | 22 | ns |
| C_{PD} | power dissipation capacitance | per package; $V_1 = GND$ to $V_{CC} - 1.5\text{ V}$ [3] | - | 4 | - | - | - | pF |

[1] t_{pd} is the same as t_{PLZ} and t_{PZL} .

[2] t_t is the same as t_{THL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

10.1. Waveforms and test circuit

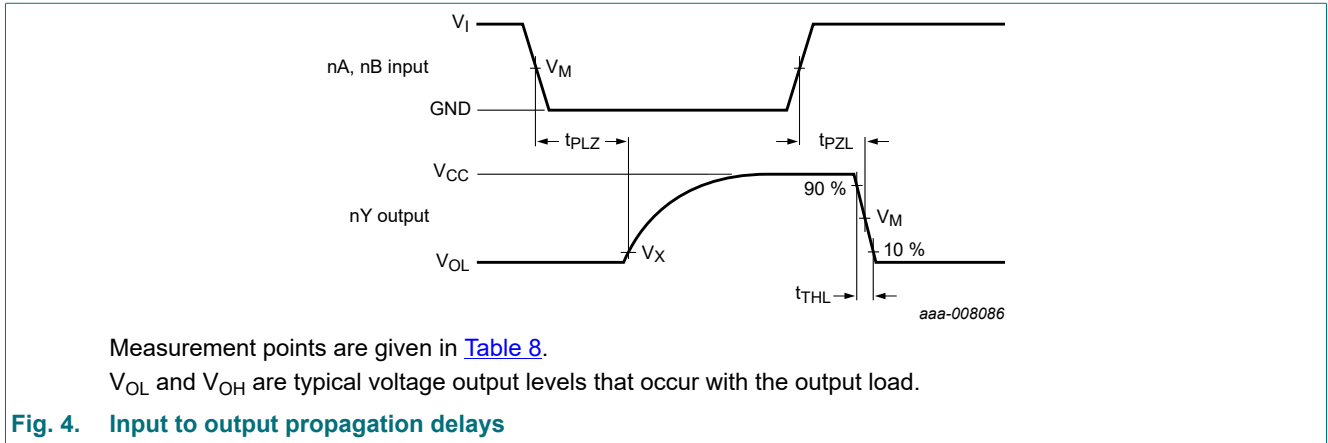


Table 8. Measurement points

| Type | Input | | Output | |
|---------|---------------------|--|---------------------|---------------------|
| | V_M | | V_M | V_X |
| 74HC03 | $0.5 \times V_{CC}$ | | $0.5 \times V_{CC}$ | $0.1 \times V_{CC}$ |
| 74HCT03 | 1.3 V | | 1.3 V | $0.1 \times V_{CC}$ |

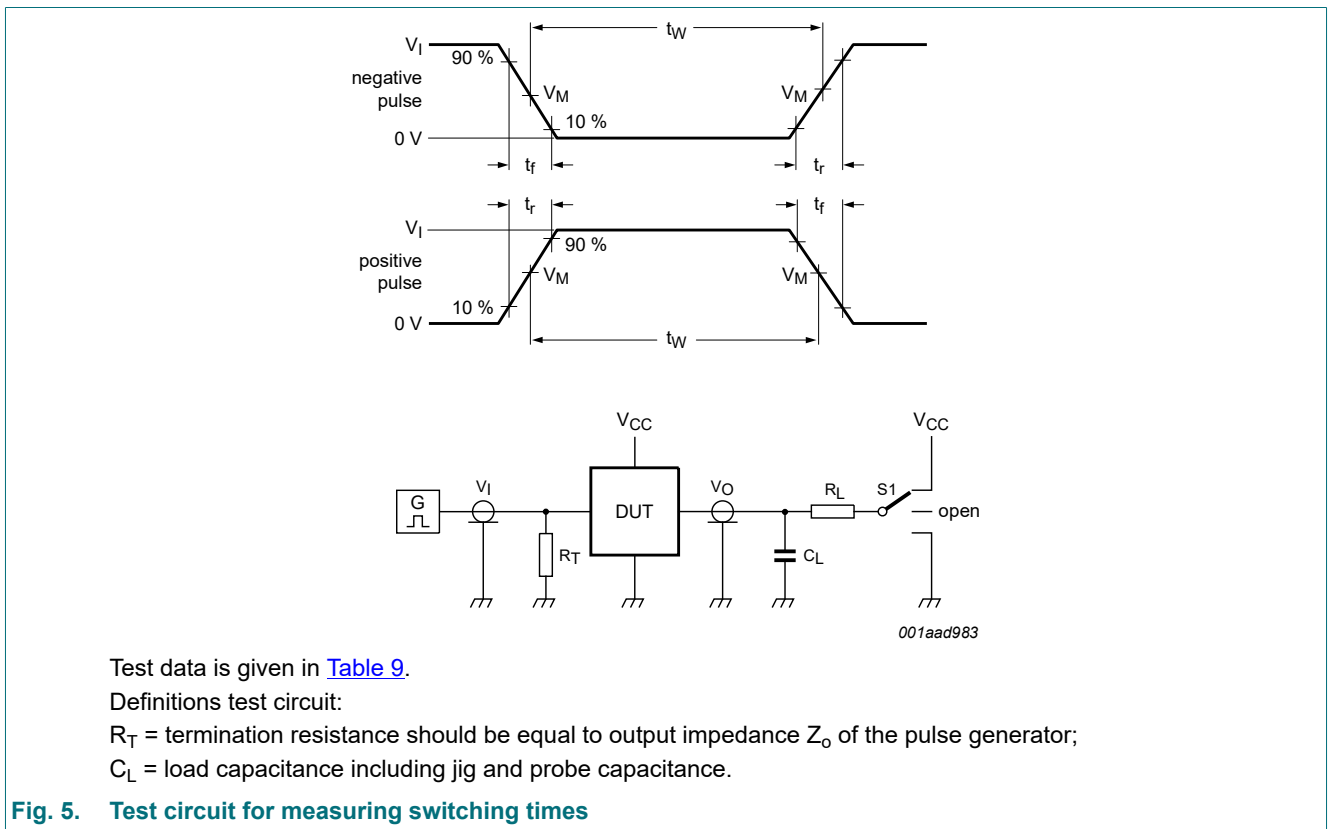


Table 9. Test data

| Type | Input | | Load | | S1 position |
|---------|----------|------------|--------------|--------------|-------------|
| | V_I | t_r, t_f | C_L | R_L | |
| 74HC03 | V_{CC} | 6 ns | 15 pF, 50 pF | 1 k Ω | V_{CC} |
| 74HCT03 | 3.0 V | 6 ns | 15 pF, 50 pF | 1 k Ω | V_{CC} |

11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

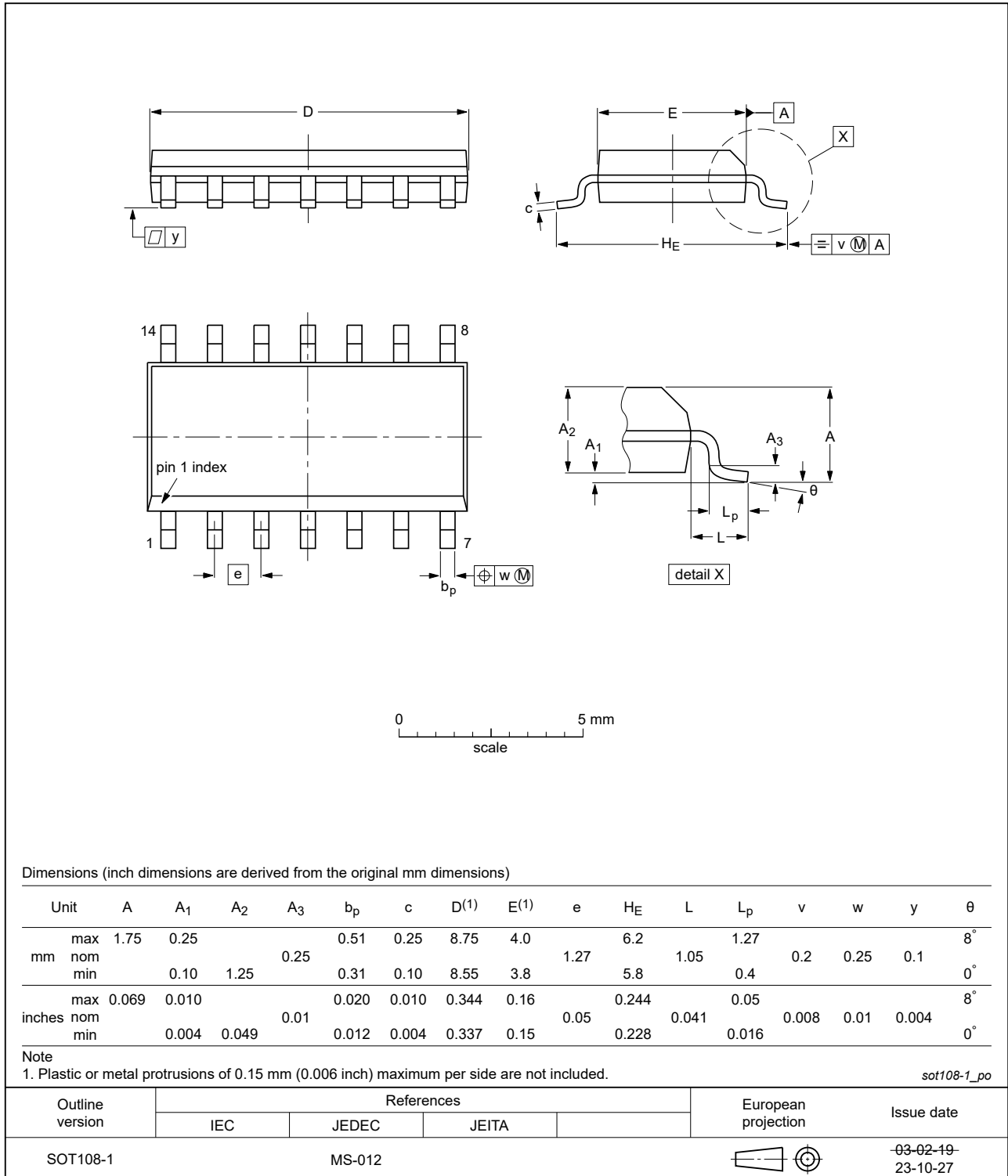


Fig. 6. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

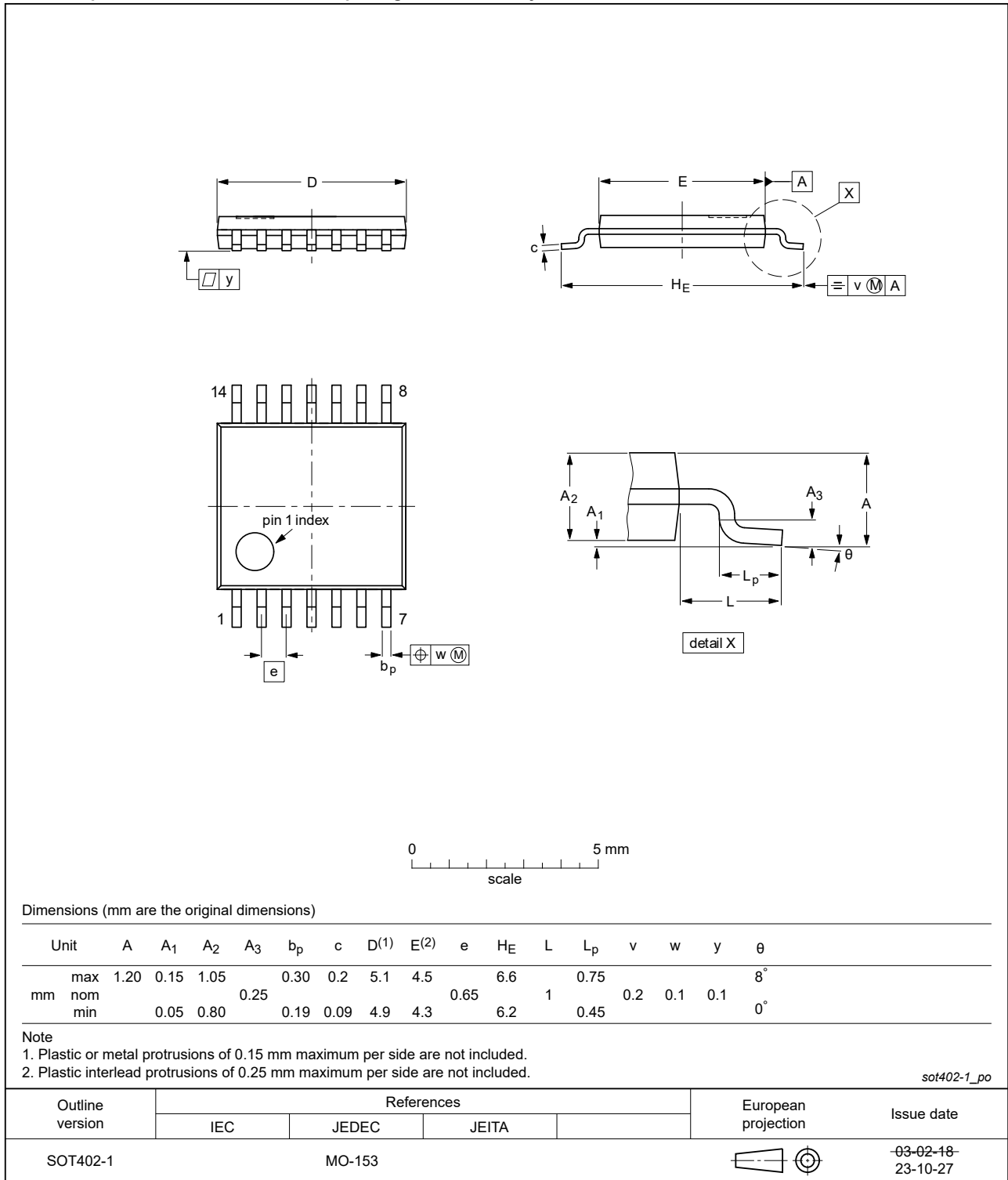


Fig. 7. Package outline SOT402-1 (TSSOP14)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CDM | Charged Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| TTL | Transistor-Transistor Logic |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------------|---|-----------------------|---------------|--------------------|
| 74HC_HCT03 v.7 | 20240216 | Product data sheet | - | 74HC_HCT03 v.6 |
| Modifications: | <ul style="list-style-type: none"> • Section 2: ESD specification updated according to the latest JEDEC standard. • Fig. 6, Fig. 7: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153 | | | |
| 74HC_HCT03 v.6 | 20210810 | Product data sheet | - | 74HC_HCT03 v.5 |
| Modifications: | <ul style="list-style-type: none"> • Section 2 updated. • Type number 74HC03DB (SOT337-1/SSOP14) removed. | | | |
| 74HC_HCT03 v.5 | 20210107 | Product data sheet | - | 74HC_HCT03 v.4 |
| Modifications: | <ul style="list-style-type: none"> • The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Type number 74HCT03DB (SOT337-1 / SSOP14) removed. • Section 7: Derating values for P_{tot} total power dissipation have been updated. | | | |
| 74HC_HCT03 v.4 | 20151127 | Product data sheet | - | 74HC_HCT03 v.3 |
| Modifications: | <ul style="list-style-type: none"> • Type numbers 74HC03N and 74HCT03N (SOT27-1) removed. | | | |
| 74HC_HCT03 v.3 | 20130627 | Product data sheet | - | 74HC_HCT03_CNV v.2 |
| Modifications: | <ul style="list-style-type: none"> • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. | | | |
| 74HC_HCT03_CNV v.2 | 19970827 | Product specification | - | - |

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| Document status [1][2] | Product status [3] | Definition |
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- [2] The term 'short data sheet' is explained in section "Definitions".
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